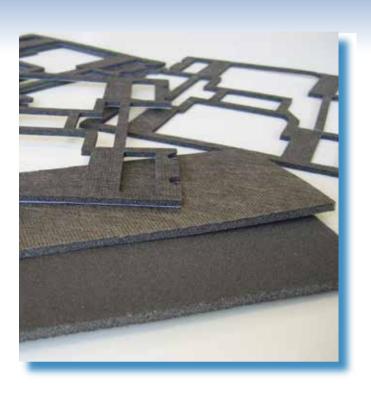


CF CONDUCTIVE FOAM

Schlegel Electronic Materials (SEM) introduces NEW CF Conductive Foam. SEM CF foam, a highly resilient Nickel-Copper plated polyurethane foam, is sandwiched between SEM's knitted and non-woven conductive fabrics to form industry leading substrate for die-cut gaskets. CF material is ideal for applications that require surface conformity with excellent cavity-to-cavity EMI shielding, superior conductivity under low compression forces and better shielding effectiveness at very high frequencies. CF foam-based gaskets are precision die-cut with a back-layer of either conductive or non-conductive pressure-sensitive-adhesive(PSA).

Schlegel's manufacturing and metal plating processes enhance the material integrity of the SEM Conductive Foam and ensure excellent galvanic compatibility even for large surface applications like I/O gaskets. The through-conductivity achieved with Schlegel CF increases the shielding effectiveness at high frequencies by shortening the return current path between the flanges.



The "New" Schlegel Electronic Materials

As the originator of the fabric-over-foam EMI Shielding Technology, Schlegel Electronic Materials is the industry's most trusted name. SEM continues to set the standard for quality and innovation, designing advanced solutions for a wide range of applications. And our worldwide locations ensure that you get what you need –when and where you need it. From concept to production, the SEM complete portfolio of Shielding products combines highly conductive materials with flexible foams and coatings to provide the latest in EMI containment solutions.

Schlegel Electronic Materials objective is to ensure that its customers have a competitive edge –by offering the highest quality and most cost-effective products conveyed with the highest level of customer service.

SEM (North America) Inc.
1600 Lexington Ave.
Suite 236A
Rochester, NY 14606

Rochester, NY 14606 T: +1 585-643-2000

F: +1 585-427-7216

E: schlegelemi.na@schlegelemi.com

SEM Belgium bvba
Slijpesteenweg 28
8432 Middelkerke (Leffinge)
Belgium
T: +32 59 560 270
F: +32 59 560 271

E: schlegelbe@schlegelemi.com

Unit 3, 3/F, Block A, New
Trade Plaza
6 On Ping Street
Shatin, N.T., Hong Kong
T: +852 2686 9872
F: +852 2686 9728
E: schlegelemi@emeigroup.com

SEM (Far East), Ltd.

SEM (Dongguan) Ltd.

No. 8 Qiaoxin Road, Qiaotou
Dongguan,
Guangdong, China
Postal Code: 523525
T: +86-769-8356 5686
F: +86-769-8334 5656
E: schlegelemi@emeigroup.com

SEM (Dongguan) Ltd.-Shanghai Office 3/F, East, No. 4 Unit, 56 Meisheng Road, Waigaoqiao P.T.Z., Pudong, Shanghai Postal Code: 200131 T: +86-21-5868 3383 F: +86-21-5868 3386 E: schlegelemi@emeigroup.com SEM (Far East) Ltd.-Taiwan Office 5/F, No. 41, Lane 76, Rei Kuang Rd. Nei-Hu Dist, Taipei, Taiwan R.O.C Postal Code: 11466 T: +886-2-2793 9055

E: schlegelemi@emeigroup.com

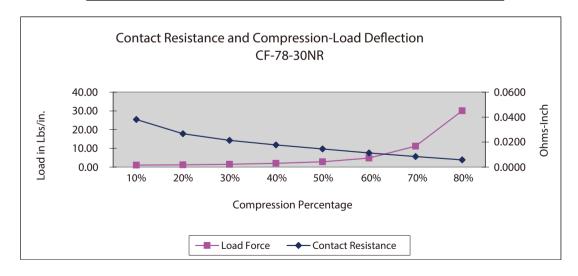
F: +886-2-2793 9501



CF CONDUCTIVE FOAM

Conductive fabrics over Nickel-Copper plated polyurethane foam			
Dimensions	Maximum Width: 22" (560mm) Thicknesses: 0.02",0.04", 0.06", 0.09", 0.13", 0.20"		
Operating Temperatures	-40°F - 156°F (-40°C - +70°C) in accordance with ASTM D3374 (Standard test methods for flexible cellular materials)		
Surface Resistivity	<0.08 Ohm/sq		
Compression set	< 15 % (compressed at 50 % during 22 Hrs. @ 70°C)		
Tensile Strength	15 kg/inch (CF-78-30FR)		
Flammability	UL94-V0 / V1 - See details at www.UL.com (SEM FE-Plastic component QMFZ2.E313523)		
Aging	No change in surface resistivity after exposure to 60°C - 90%RH - 300 hrs		
Shielding Effectiveness	>90 dB AVG. 10-1000 MHz (Tem-T Cells -Method described in IEEE Std 1302)		
Compliance	2011/65/EU (RoHS 2.0) compliant		

Thickness	Tolerance	UL Fire Rated	Part #
0.45mm	± 0.2mm	-	CF 78-05NR
1.00mm	± 0.2mm	UL94-V0	CF-78-10FR
1.50mm	± 0.2mm	UL94-V0	CF-78-14FR
1.50mm	± 0.2mm	-	CF-78-14NR
2.30mm	± 0.3mm	UL94-V0	CF-78-20FR
2.30mm	± 0.3mm	-	CF-78-20NR
3.40mm	± 0.3mm	UL94-V1	CF-78-30FR
3.40mm	± 0.3mm	-	CF-78-30NR
5.00mm	± 0.5mm	-	CF-78-50NR



www.schlegelemi.com

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